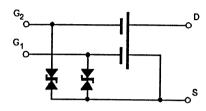
## N-channel dual gate MOS-fieldeffect tetrode. Depletion mode.

Electrostatic sensitive device. Observe precautions for handling.



## **Applications**

Input- and mixer stages in UHF- and VHF-tuner.

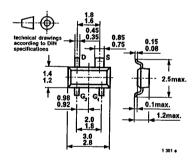


#### **Features**

- Integrated gate protection diodes
- Low noise figure
- Low feedback capacitance
- High cross modulation performance
- Low input capacitance

- High AGC-range
- High gain
- Available with reverse pin configuration (S 898 TR) on request

#### **Dimensions in mm**



Marking: MO

Plastic case (SOT 143)

## **Absolute Maximum Ratings**

Parameters	Symbol	Value	Unit
Drain source voltage	$V_{DS}$	12	V
Drain current	$I_{\mathrm{D}}$	30	mA
Gate 1/gate 2-source peak current	±I <sub>G1/G2SM</sub>	10	mA
Gate 1/gate 2-source voltage	±V <sub>G1S/G2S</sub>	7	V
Total power dissipation $T_{amb} \le 60^{\circ}C$	P <sub>tot</sub>	200	mW
Channel temperature	T <sub>Ch</sub>	150	°C
Storage temperature range	T <sub>stg</sub>	-65 to +150	°C

## **Maximum Thermal Resistance**

Parameters	Symbol	Maximum	Unit
Channel ambient on glass fibre printed board (25 x 20 x 1.5) mm <sup>3</sup> plated with 35 µm Cu	R <sub>thChA</sub>	450	K/W

## **Electrical DC Characteristics**

 $T_{amb} = 25^{\circ}C$ 

Parameters / Test Conditions	Symbol	Min.	Тур.	Max.	Unit
Drain-source breakdown voltage $I_D = 10 \; \mu A, \; -V_{G1S} = -V_{G2S} = 4 \; V$	V <sub>(BR)DS</sub>	12			V
Gate 1-source breakdown voltage $\pm I_{G1S} = 10 \text{ mA}, V_{G2S} = V_{DS} = 0 \text{ V}$	±V <sub>(BR)G1SS</sub>	8		14	V
Gate 2-source breakdown voltage $\pm I_{G2S} = 10 \text{ mA}, V_{G1S} = V_{DS} = 0 \text{ V}$	±V <sub>(BR)G2SS</sub>	8		14	V
Gate 1-source cut-off current $\pm V_{G1S} = 5 \text{ V}, V_{G2S} = V_{DS} = 0 \text{ V}$	$I_{G1SS}$			50	nA
Gate 2-source cut-off current $\pm V_{G2S} = 5 \text{ V}, V_{G1S} = V_{DS} = 0 \text{ V}$	I <sub>G2SS</sub>			50	nA
Drain current $V_{DS} = 8 \text{ V}, V_{G1S} = 0 \text{ V}, V_{G2S} = 4 \text{ V}$	I <sub>DSS</sub>	4		18	mA
Gate 1-source cut-off voltage $V_{DS} = 8 \text{ V},  V_{G2S} = 4 \text{ V},  I_D = 20  \mu A$	-V <sub>G1S(OFF)</sub>		1.0	2.0	V
Gate 2-source cut-off voltage $V_{DS} = 8 \text{ V},  V_{G1S} = 0 \text{ V},  I_D = 20  \mu A$	-V <sub>G2S(OFF)</sub>		0.6	1.0	V

#### **Electrical AC Characteristics**

 $V_{DS} = 8$  V,  $I_D = 10$  mA,  $V_{G2S} = 4$  V, f = 1 MHz,  $T_{amb} = 25$ °C

Parameters / Test Conditions	Symbol	Min.	Тур.	Max.	Unit
Forward transadmittance	y <sub>21s</sub>	21		25	mS
Gate 1 input capacitance	C <sub>issg1</sub>		2.1	2.5	pF
Gate 2 input capacitance $V_{G1S} = 0 \text{ V}, V_{G2S} = 4 \text{ V}$	C <sub>issg2</sub>		1.1		pF
Feedback capacitance	C <sub>rss</sub>		25		fF
Output capacitance	Coss		1.05		pF
$\begin{aligned} & \text{Power gain} \\ & G_S = 2 \text{ mS}, G_L = 0.5 \text{ mS}, f = 200 \text{ MHz} \\ & G_S = 3.3 \text{ mS}, G_L = 1 \text{ mS}, f = 800 \text{ MHz} \end{aligned}$	$\begin{array}{c} G_{ps} \\ G_{ps} \end{array}$	16.5	28 20		dB dB
AGC range $V_{G2S} = 4 \text{ to}-2 \text{ V, f} = 800 \text{ MHz}$	$\Delta G_{ m ps}$	40			dB
Noise figure $G_S=2~\text{mS},~G_L=0.5~\text{mS},~f=200~\text{MHz} \\ G_S=3.3~\text{mS},~G_L=1~\text{mS},~f=800~\text{MHz} \\ \label{eq:GS}$	F F		1.1 1.6		dB dB

# S 898 T



#### We reserve the right to make changes without further notice to improve technical design.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by customer. Should Buyer use TEMIC products for any unintended or unauthorized application, Buyer shall indemnify TEMIC against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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